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CRYSTAL OSCILLATOR (Programmable) OUTPUT: CMOS SG-8018series

• Frequency range: 0.67 MHz to 170 MHz (1 ppm Step)

- Supply voltage : 1.62 V to 3.63 V
- Function : Output enable (OE) or Standby (ST)
- Frequency tolerance : ±50 ppm (-40 °C to +105 °C)
- Include frequency aging(+25 °C, 10 years)
- Package : 2.5 x 2.0, 3.2 x 2.5, 5.0 x 3.2, 7.0 x 5.0 (mm)
- PLL technology to enable short lead time
- Available field oscillator programmer "SG-Writer II"



CG

CB CA 2.5 x 2.0mm 3.2 x 2.5mm 5.0 x 3.2mm 7.0 x 5.0mm

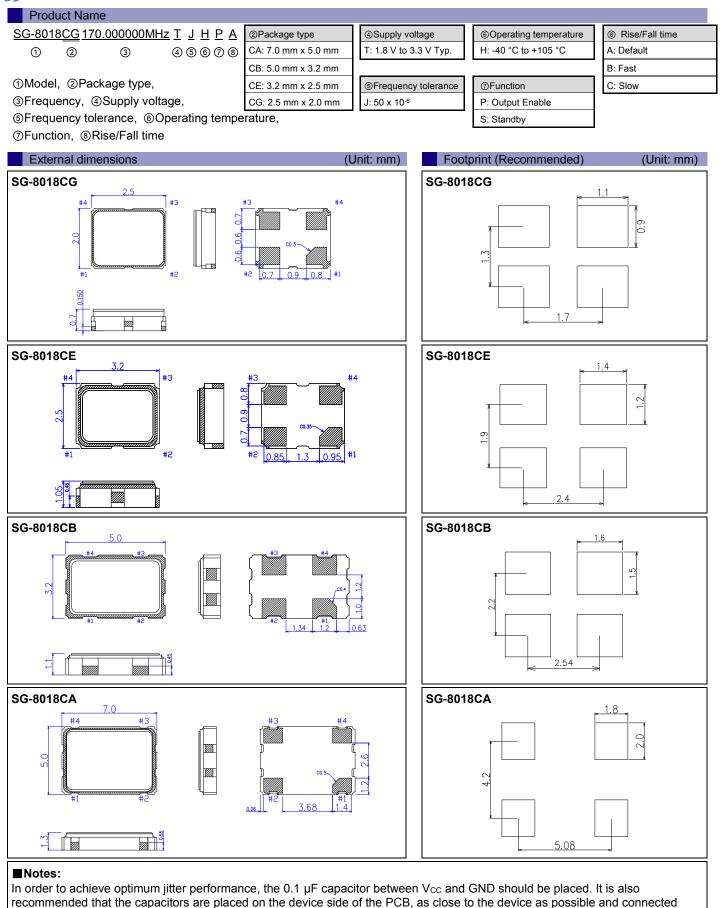
Specificatio	ns (charac	teristics)										
Item	า	Symbol	Specifications				Conditions/Remarks					
Supply voltage		Vcc	1.80 \									
		VCC	1.62 V to 1.98 V	-								
Output frequenc	y range	fo		0.67 MHz 1	to 170 MHz							
Storage tempera	ature	T_stg		-40 °C to	Storage as single p	roduct						
Operating tempe		T_use			o +105 ℃				-			
Frequency tolera	ance ^{*1}	f_tol		J: ±50) × 10 ⁻⁶		T_use = -40 °C to +	-105 °C)			
			3.2 mA Max.	3.3 mA Max.	3.4 mA Max.	3.5 mA Max.	T_use = +105 °C	No loa	ad, fo =	20 M⊦	17	
Current consum	ntion	lcc		nA Typ.	2.9 mA Typ.	3.0 mA Typ.	T_use = +25 °C	110 100	iu , 10	20 1011	12	
ourion concum	ption	.00	5.5 mA Max.	5.8 mA Max.	6.7 mA Max.	8.1 mA Max.	T_use = +105 °C	No loa	ad, f _o =	170 M	IHz	
				nA Typ.	5.7 mA Typ.	6.8 mA Typ.	T_use = +25 °C		, .0			
Output disable c	urrent	I_dis	3.2 mA Max.	3.2 mA Max.	3.3 mA Max.	3.5 mA Max.	OE = GND, f _o = 170) MHz				
Standby current		I std	0.9 µA Max.	1.0 µA Max.	1.5 µA Max.	2.5 µA Max.	T_use = +105 °C	ST =	GND			
		-	0.3 µA Typ.	0.4 µA Typ.	0.5 μA Typ.	1.1 µA Typ.	T_use = +25 °C					
Symmetry		SYM		45 % t	0 55 %		50 % V _{CC} Level					
							I _{OH} /I _{OL} Conditions [mA] Rise/Fall time V _{CC} *A *B *C *D					
		Vон		$\begin{array}{c c} \text{Default (fo > 40 MHz),} & \text{IoH} & -\\ \hline \text{Fast} & & \text{IoL} \\ \hline \text{Default (fo < 40 MHz)} & \text{IoH} & -\\ \end{array}$	-2.5	-3.5		-5.0				
						2.5	3.5		5.0			
Output voltage					I _{OH}	-1.5	-2.0		-3.0			
(DC characterist	ics)		10 % Vcc Max.					/ Iol	1.5	2.0	2.5	3.0
		Vol					Slow	Іон	-1.0 1.0	-1.5 1.5		-2.5 2.5
							*A: 1.62 V to 1.98 V, *B: 1.98 V to 2.20 V,					
				*C: 2.20 V to 2.80 V, *D: 2.70 V to 3.63 V								
Output load cond	dition	L_CMOS		15 p	oF Max.				-			
Input voltage		VIH										
Input voltage		VIL		30 % V	OE or ST							
				3.0 ns Max.								
Rise and Fall	Default		6.0 ns Max.				$f_0 > 40 \text{ MHz}$ $f_0 \le 40 \text{ MHz}$ 20 % - 80 % V _{CC}					
time	Fast	tr/tf		3.0 1	ns Max.		f _O = 0.67 MHz to 17	'0 MHz	L_CN	OS =	15 pF	
	Slow	_	10.0 ns Max.				f ₀ = 0.67 MHz to 20					
Disable Time t_str		t_stp	75	Measured from the time OE or \overline{ST} pin crosses 30 % V_{cc}								
Enable Time		t_sta		Measured from the time OE pin crosses 70 % V_{CC}				Vcc				
Resume Time		t_res		3 n	ns Max.		Measured from the time \overline{ST} pin crosses 70 % V _{CC}				Vcc	
Start-up time		t_str		Measured from the time V_{CC} reaches its rated minimum value, 1.62 V								
Frequency aging	9	f_aging	This is included in frequency tolerance specification.				+25 °C, 10 years					

*1 Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage variation, reflow drift, load drift and aging (+25 °C, 10 years).

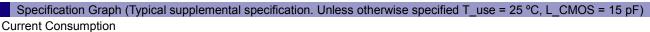
Pin description				
Pin Name		I/O type		Function
	OE	Input	Output enable	High: Specified frequency output from OUT pin
	UE	input		Low: Out pin is low (weak pull down), only output driver is disabled.
1	1			High: Specified frequency output from OUT pin
	ST	Input	Standby	Low: Out pin is low (weak pull down),
				Device goes to standby mode. Supply current reduces to the least as I_std.
2	GND	Power	Ground	
3	OUT	Output	Clock output	
4	V _{cc}	Power	Power supply	

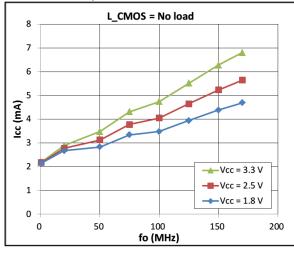


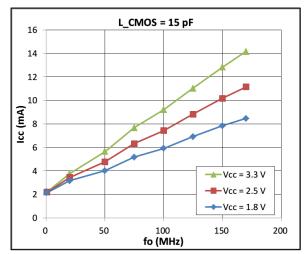
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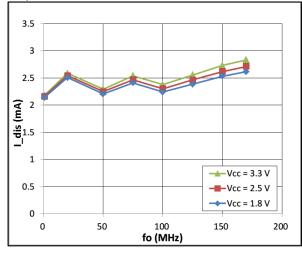
together with short wiring pattern.



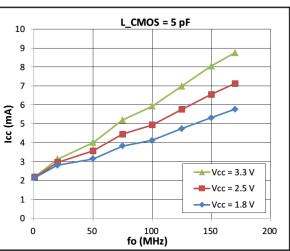


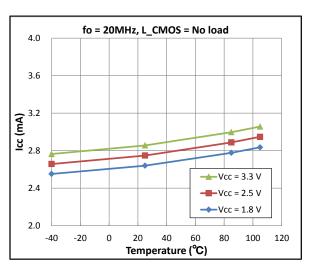


Output disable current

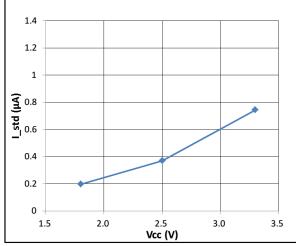


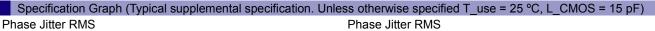
Notes:



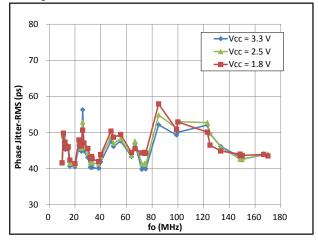


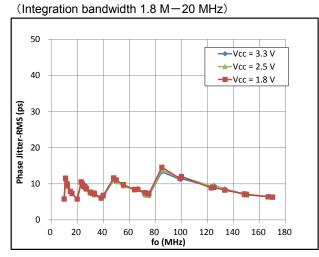




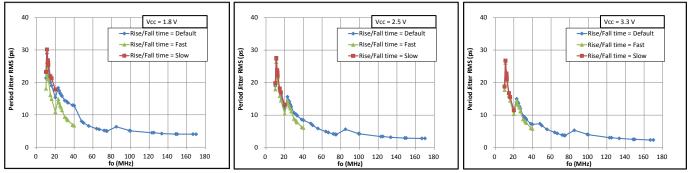


(Integration bandwidth 12 k-20 MHz)





Period Jitter RMS



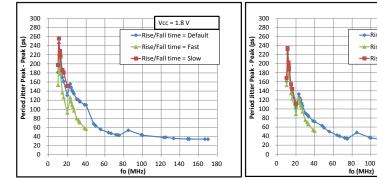
Vcc = 2.5 V

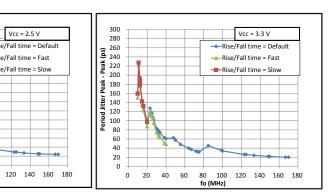
Rise/Fall time = Default

...

Rise/Fall time = Slow

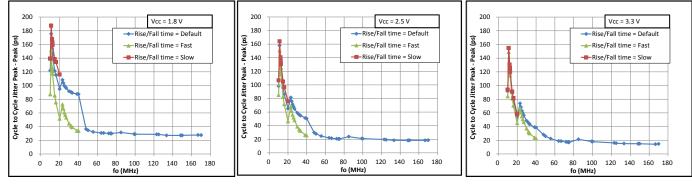
Period Jitter Peak-Peak





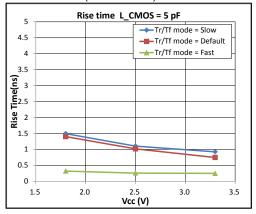
Cycle-to-Cycle Jitter Peak-Peak

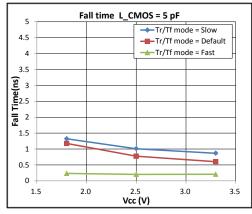
Notes:

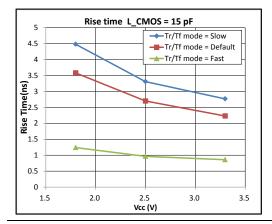


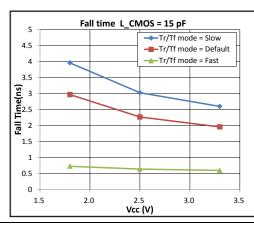
Specification Graph

(Typical supplemental specification. Unless otherwise specified T_use = 25 °C, L_CMOS = 15 pF, VCC = 3.3 V) Rise/Fall Time (fo = 20 MHz)

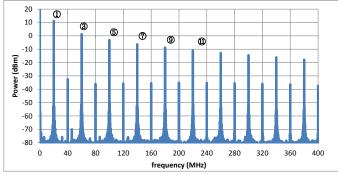




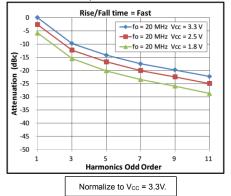


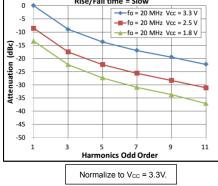


Harmonics spectrum (fo = 20 MHz)

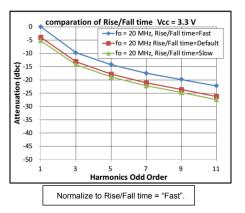


Harmonics comparison





Rise/Fall time = Slow

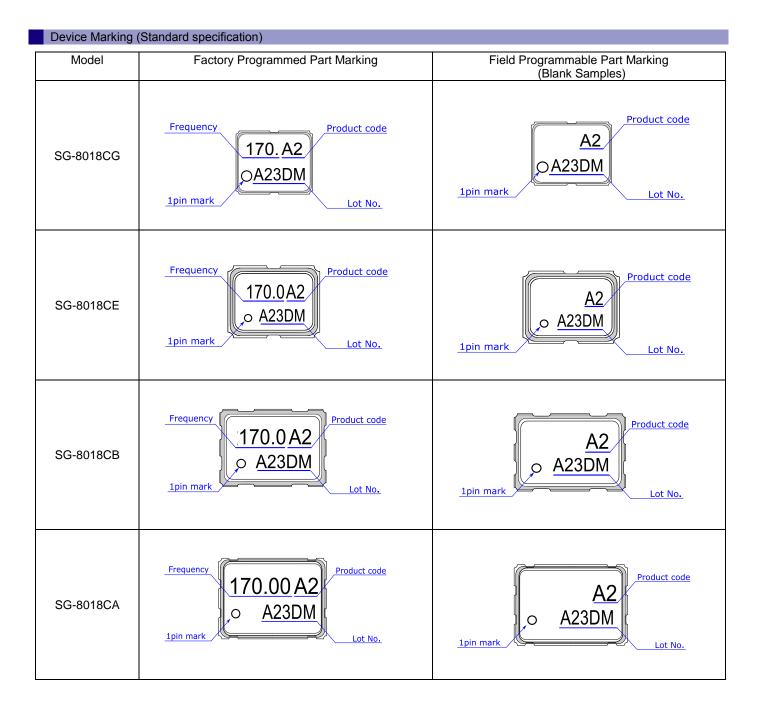


	frequency	slow	default	fast
	0.67 M – 20 MHz	See Slow	See Default	See Fast
	20 M – 40 MHz	-	See Default	See Fast
	40 M – 170 MHz	-	See Fast	See Fast
1				



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ESD Railing							
Test items	Breakdown voltage						
Human Body Model (HBM)	2000 V						
Machine Model (MM)	250 V						
Charged Device Model (CDM)	750 V						



Simulation Model

IBIS Model is available upon request. Please contact us. Information Required: Oscillator operating condition (i.e. Power Supply, Rise/Fall Time, Temperature) Crystal oscillator

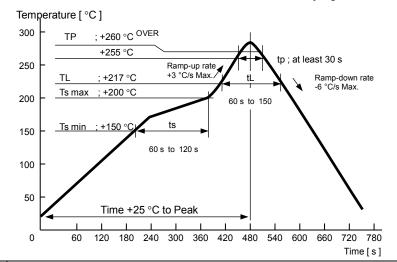
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Device Material & Environmental Information

Model	Package	# of	Reference	Terminal	Terminal	Complies	Pb	MSL	Peak
	Dimensions	Pins	Weight	Material	Plating	With EU	Free	Rating	Temp.
			(Typ.)			RoHS		-	(Max)
SG-8018CG	2.5 x 2.0 x 0.7 mm	4	13 mg	W	Au	Yes	Yes	1	260 °C
SG-8018CE	3.2 x 2.5 x 1.0 mm	4	25 mg	W	Au	Yes	Yes	1	260 °C
SG-8018CB	5.0 x 3.2 x 1.1 mm	4	51 mg	W	Au	Yes	Yes	1	260 °C
SG-8018CA	7.0 x 5.0 x 1.3 mm	4	143 mg	W	Au	Yes	Yes	1	260 °C

SMD products Reflow profile(example)

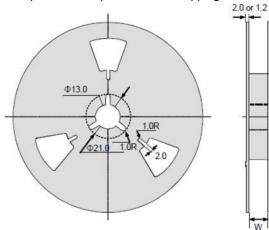
The availability of the heat resistance for reflow conditions of JEDEC-STD-020D.01 is judged individually. Please inquire.

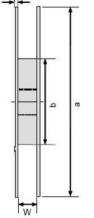


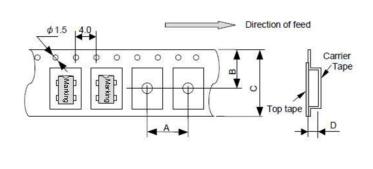
Pb Free	Pb free.
RoHS Compliant	 Complies with EU RoHS directive. About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)

Standard Packing Specification

SMD products are packed in the shipping carton as below table in accordance with taping standards EIA-481 and IEC-60286







Standard Pac	Standard Packing Quantity & Dimension(Unit mm)								
	Quantity	Reel Dimension			Car	Direction of			
Model	(pcs/Reel)	а	b	W	А	В	С	D	Feed (L= Left Direction)
SG-8018CG	3000	Φ180	Ф60	9	4	5.25	8	1.15	L
SG-8018CE	2000	Φ180	Ф60	9	4	5.25	8	1.4	L
SG-8018CB	1000	Φ180	Ф60	13	8	7.25	12	1.4	L
SG-8018CA	1000	Φ254	Φ100	17.5	8	9.25	16	2.3	L

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs,

Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired ISO/TS 16949 certification that is requested strongly by major automotive manufacturers as standard.

Explanation of the mark that are using it for the catalog

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

ISO/TS16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Pb Free	► Pb free.
RoHS	 Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
For Automotive	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
Attionotive safety	► Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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